

L Number	Hits	Search Text	DB	Time stamp
1	1	6083628.pn.	USPAT; US-PGPUB	2003/10/27 08:42
2	7632	cyanoacrylate	USPAT; US-PGPUB	2003/10/27 08:43
3	9	cyanoacrylate with (cyanoethylacrylate)	USPAT; US-PGPUB	2003/10/27 08:46
4	1	6214422.pn. and (cyano near3 acrylate)	USPAT; US-PGPUB	2003/10/27 08:47
5	0	6214422.pn. and cyanoacrylate	USPAT; US-PGPUB	2003/10/27 08:51
6	0	(plasma near2 polymeri\$9) and (cyanoacrylate or (cyano near3 acrylate) or cyanoethylacrylate or ethylcyanoacrylate) with (\$5phosphoric adj acid))	USPAT; US-PGPUB	2003/10/27 08:53
7	12	(plasma near2 polymeri\$9) and (cyanoacrylate or (cyano near3 acrylate) or cyanoethylacrylate or ethylcyanoacrylate) with (acid))	USPAT; US-PGPUB	2003/10/27 08:55
8	38	((cyanoacrylate or (cyano near3 acrylate) or cyanoethylacrylate or ethylcyanoacrylate) with (\$5phosphoric adj acid))	USPAT; US-PGPUB	2003/10/27 09:13
9	1	5032461.pn.	USPAT; US-PGPUB	2003/10/27 09:14
10	2	4842893.pn. or 4954371.pn.	USPAT; US-PGPUB	2003/10/27 09:38
11	4	"9612051"	EPO; JPO; DERWENT; IBM_TDB	2003/10/27 09:45
12	3	"9731034"	EPO; JPO; DERWENT; IBM_TDB	2003/10/27 10:29
-	1	6126776.pn.	USPAT; US-PGPUB	2003/10/21 13:20
-	3	((("N.K.T. Research").as. or ("NKT research").as. or Jensen.in. or Glejbol.in.) and (metalliz\$6 near5 polymer)	USPAT; US-PGPUB	2003/10/21 13:29
-	2	((("N.K.T. Research").as. or ("NKT research").as. or Jensen.in. or Glejbol.in.) and (plasma near2 polymeri\$7) and ((deposit\$3 or \$4CVD or PVD or sputter\$4) near3 metal\$5)	USPAT; US-PGPUB	2003/10/21 13:28
-	1	((("N.K.T. Research") or ("NKT research") or Jensen or Glejbol) and (plasma near2 polymeri\$7) and ((deposit\$3 or \$4CVD or PVD or sputter\$4) near3 metal\$5)	EPO; JPO; DERWENT; IBM_TDB	2003/10/21 13:29
-	15	((("N.K.T. Research") or ("NKT research") or Jensen or Glejbol) and (metalliz\$6 near5 polymer)	USPAT; US-PGPUB	2003/10/21 13:31
-	1	((("N.K.T. Research") or ("NKT research") or Jensen or Glejbol) and (metalliz\$6 near5 polymer)	EPO; JPO; DERWENT; IBM_TDB	2003/10/23 10:11
-	361	(427/488,491).CCLS.	USPAT; US-PGPUB	2003/10/23 10:11
-	1179	(427/533,534,535,536).CCLS.	USPAT; US-PGPUB	2003/10/23 10:11
-	2657	(427/250,255.6,255.7).CCLS.	USPAT; US-PGPUB	2003/10/23 10:12
-	1074	(427/304,305).CCLS.	USPAT; US-PGPUB	2003/10/23 10:12
-	636	(427/306).CCLS.	USPAT; US-PGPUB	2003/10/23 10:12
-	940	(427/437,443.1).CCLS.	USPAT; US-PGPUB	2003/10/23 10:12
-	162	(204/192.14).CCLS.	USPAT; US-PGPUB	2003/10/23 10:13
-	121	(205/158,165).CCLS.	USPAT; US-PGPUB	2003/10/23 10:13

-	186	(205/205).CCLS.	USPAT; US-PGPUB	2003/10/23 10:13
-	6224	((427/488,491).CCLS.) ((427/533,534,535,536).CCLS.) ((427/537).CCLS.) ((427/250,255.6,255.7).CCLS.) ((427/304,305).CCLS.) ((427/306).CCLS.) ((427/437,443.1).CCLS.) ((204/192.14).CCLS.) ((205/158,165).CCLS.) ((205/205).CCLS.)	USPAT; US-PGPUB	2003/10/23 10:14
-	4	((427/537).CCLS.) and ((427/306).CCLS.)	USPAT; US-PGPUB	2003/10/23 10:16
-	1	6221440.pn.	USPAT; US-PGPUB	2003/10/23 10:17
-	1	((427/488,491).CCLS.) and ((427/533,534,535,536).CCLS.) or ((427/537).CCLS.) and ((427/304,305).CCLS.) or ((427/306).CCLS.) or ((427/437,443.1).CCLS.) or ((205/158,165).CCLS.) or ((205/205).CCLS.)	USPAT; US-PGPUB	2003/10/23 10:21
-	1	((427/488,491).CCLS.) and ((427/304,305).CCLS.) or ((427/306).CCLS.) or ((427/437,443.1).CCLS.) or ((205/158,165).CCLS.) or ((205/205).CCLS.)	USPAT; US-PGPUB	2003/10/23 10:20
-	101	(427/537).CCLS.	USPAT; US-PGPUB	2003/10/23 10:29
-	85	((427/488,491).CCLS.) and ((427/533,534,535,536).CCLS.) or ((427/537).CCLS.)	USPAT; US-PGPUB	2003/10/23 10:21
-	0	("L3notL16").PN.	USPAT; US-PGPUB	2003/10/23 10:29
-	99	((427/537).CCLS.) not ((427/488,491).CCLS.) and ((427/533,534,535,536).CCLS.) or ((427/537).CCLS.)	USPAT; US-PGPUB	2003/10/23 10:52
-	17	((427/488,491).CCLS.) and (electroplat\$5 or (electroless) or (electro adj less))	USPAT; US-PGPUB	2003/10/23 10:54
-	5	((427/488,491).CCLS.) ((427/533,534,535,536).CCLS.) ((427/537).CCLS.) ((427/250,255.6,255.7).CCLS.) ((427/304,305).CCLS.) ((427/306).CCLS.) ((427/437,443.1).CCLS.) ((204/192.14).CCLS.) ((205/158,165).CCLS.) ((205/205).CCLS.) and (metalliz\$6 near5 (polymer\$2 or organic or resin)) and (plasma with (clean\$3 or treat\$4 or pretreat\$4 or radical or etch\$3)) and (plasma near4 polymeri\$7) and ((PVD or \$3CVD or (vapor near2 deposit\$3) or sputter\$3) near5 (metal\$3 or Cu or copper or tin or Sn or silver or Ag or palladium or Pd or platinum or Pt or gold or Au))	USPAT; US-PGPUB	2003/10/23 11:30
-	3	((427/488,491).CCLS.) and (metalliz\$6 near5 (polymer\$2 or organic or resin)) and ((PVD or \$3CVD or (vapor near2 deposit\$3) or sputter\$3) near5 (metal\$3 or Cu or copper or tin or Sn or silver or Ag or palladium or Pd or platinum or Pt or gold or Au))	USPAT; US-PGPUB	2003/10/23 11:03

-	20	((metalliz\$6 near5 (polymer\$2 or organic or resin)) and (plasma with (clean\$3 or treat\$4 or pretreat\$4 or radical or etch\$3)) and (plasma near4 polymeri\$7) and ((PVD or \$3CVD or (vapor near2 deposit\$3) or sputter\$3) near5 (metal\$3 or Cu or copper or tin or Sn or silver or Ag or palladium or Pd or platinum or Pt or gold or Au)))	USPAT; US-PGPUB	2003/10/23 11:07
-	15	((metalliz\$6 near5 (polymer\$2 or organic or resin)) and (plasma with (clean\$3 or treat\$4 or pretreat\$4 or radical or etch\$3)) and (plasma near4 polymeri\$7) and ((PVD or \$3CVD or (vapor near2 deposit\$3) or sputter\$3) near5 (metal\$3 or Cu or copper or tin or Sn or silver or Ag or palladium or Pd or platinum or Pt or gold or Au))) not (((427/488,491).CCLS.) ((427/533,534,535,536).CCLS.) ((427/537).CCLS.) ((427/250,255.6,255.7).CCLS.) ((427/304,305).CCLS.) ((427/306).CCLS.) ((427/437,443.1).CCLS.) ((204/192.14).CCLS.) ((205/158,165).CCLS.) ((205/205).CCLS.)) and (metalliz\$6 near5 (polymer\$2 or organic or resin)) and (plasma with (clean\$3 or treat\$4 or pretreat\$4 or radical or etch\$3)) and (plasma near4 polymeri\$7) and ((PVD or \$3CVD or (vapor near2 deposit\$3) or sputter\$3) near5 (metal\$3 or Cu or copper or tin or Sn or silver or Ag or palladium or Pd or platinum or Pt or gold or Au)))	USPAT; US-PGPUB	2003/10/23 11:04
-	176	((metal\$9 near5 (polymer\$2 or organic or resin)) and (plasma with (clean\$3 or treat\$4 or pretreat\$4 or radical or etch\$3)) and (plasma near4 polymeri\$7) and ((PVD or \$3CVD or (vapor near2 deposit\$3) or sputter\$3) near5 (metal\$3 or Cu or copper or tin or Sn or silver or Ag or palladium or Pd or platinum or Pt or gold or Au)))	USPAT; US-PGPUB	2003/10/23 11:18
-	33	((metal\$9 near5 (polymer\$2 or organic or resin)) and (plasma with (clean\$3 or treat\$4 or pretreat\$4 or radical or etch\$3)) and (plasma near4 polymeri\$7) and ((PVD or \$3CVD or (vapor near2 deposit\$3) or sputter\$3) near5 (metal\$3 or Cu or copper or tin or Sn or silver or Ag or palladium or Pd or platinum or Pt or gold or Au))) and (((427/488,491).CCLS.) ((427/533,534,535,536).CCLS.) ((427/537).CCLS.) ((427/250,255.6,255.7).CCLS.) ((427/304,305).CCLS.) ((427/306).CCLS.) ((427/437,443.1).CCLS.) ((204/192.14).CCLS.) ((205/158,165).CCLS.) ((205/205).CCLS.))	USPAT; US-PGPUB	2003/10/23 11:08

-	28	((metal\$9 near5 (polymer\$2 or organic or resin)) and (plasma with (clean\$3 or treat\$4 or pretreat\$4 or radical or etch\$3)) and (plasma near4 polymeri\$7) and ((PVD or \$3CVD or (vapor near2 deposit\$3) or sputter\$3) near5 (metal\$3 or Cu or copper or tin or Sn or silver or Ag or palladium or Pd or platinum or Pt or gold or Au))) and (((427/488,491).CCLS.) ((427/533,534,535,536).CCLS.) ((427/537).CCLS.) ((427/250,255.6,255.7).CCLS.) ((427/304,305).CCLS.) ((427/306).CCLS.) ((427/437,443.1).CCLS.) ((204/192.14).CCLS.) ((205/158,165).CCLS.) ((205/205).CCLS.))) not ((metalliz\$6 near5 (polymer\$2 or organic or resin)) and (plasma with (clean\$3 or treat\$4 or pretreat\$4 or radical or etch\$3)) and (plasma near4 polymeri\$7) and ((PVD or \$3CVD or (vapor near2 deposit\$3) or sputter\$3) near5 (metal\$3 or Cu or copper or tin or Sn or silver or Ag or palladium or Pd or platinum or Pt or gold or Au)))	USPAT; US-PGPUB	2003/10/23 11:11
-	143	((metal\$9 near5 (polymer\$2 or organic or resin)) and (plasma with (clean\$3 or treat\$4 or pretreat\$4 or radical or etch\$3)) and (plasma near4 polymeri\$7) and ((PVD or \$3CVD or (vapor near2 deposit\$3) or sputter\$3) near5 (metal\$3 or Cu or copper or tin or Sn or silver or Ag or palladium or Pd or platinum or Pt or gold or Au))) not (((metal\$9 near5 (polymer\$2 or organic or resin)) and (plasma with (clean\$3 or treat\$4 or pretreat\$4 or radical or etch\$3)) and (plasma near4 polymeri\$7) and ((PVD or \$3CVD or (vapor near2 deposit\$3) or sputter\$3) near5 (metal\$3 or Cu or copper or tin or Sn or silver or Ag or palladium or Pd or platinum or Pt or gold or Au))) and (((427/488,491).CCLS.) ((427/533,534,535,536).CCLS.) ((427/537).CCLS.) ((427/250,255.6,255.7).CCLS.) ((427/304,305).CCLS.) ((427/306).CCLS.) ((427/437,443.1).CCLS.) ((204/192.14).CCLS.) ((205/158,165).CCLS.) ((205/205).CCLS.)))	USPAT; US-PGPUB	2003/10/23 11:12
-	59	(metal\$10 near5 (polymer\$2 or organic or resin)) and (plasma with (prim\$4 or clean\$3 or treat\$4 or pretreat\$4 or radical or etch\$3)) and (plasma near4 polymeri\$7) and ((PVD or \$3CVD or (vapor near2 deposit\$3) or sputter\$3) near5 (metal\$3 or Cu or copper or tin or Sn or silver or Ag or palladium or Pd or platinum or Pt or gold or Au)) and (electroless or (electro adj less) or electroplat\$3 or electrolytic\$5)	USPAT; US-PGPUB	2003/10/23 11:22
-	1	(metal\$10 near5 (polymer\$2 or organic or resin)) and (plasma with (prim\$4 or clean\$3 or treat\$4 or pretreat\$4 or radical or etch\$3)) and (plasma near4 polymeri\$7) and ((PVD or \$3CVD or (vapor near2 deposit\$3) or sputter\$3) near5 (metal\$3 or Cu or copper or tin or Sn or silver or Ag or palladium or Pd or platinum or Pt or gold or Au)) and (electroless or (electro adj less) or electroplat\$3 or electrolytic\$5)	EPO; JPO; DERWENT; IBM_TDB	2003/10/23 11:23

-	1	(metal\$10 near5 (polymer\$2 or organic or resin)) and (plasma with (prim\$4 or clean\$3 or treat\$4 or pretreat\$4 or radical or etch\$3)) and (plasma near4 polymeri\$7) and ((PVD or \$3CVD or (deposit\$3) or sputter\$3) near5 (metal\$3 or Cu or copper or tin or Sn or silver or Ag or palladium or Pd or platinum or Pt or gold or Au)) and (electroless or (electro adj less) or electroplat\$3 or electrolytic\$5)	EPO; JPO; DERWENT; IBM_TDB	2003/10/23 11:23
-	5	(metal\$10 near5 (polymer\$2 or organic or resin)) and (plasma with (prim\$4 or clean\$3 or treat\$4 or pretreat\$4 or radical or etch\$3)) and (plasma near4 polymeri\$7) and ((PVD or \$3CVD or (vapor near2 deposit\$3) or sputter\$3) near5 (metal\$3 or Cu or copper or tin or Sn or silver or Ag or palladium or Pd or platinum or Pt or gold or Au))	EPO; JPO; DERWENT; IBM_TDB	2003/10/23 11:27
-	4	((metal\$10 near5 (polymer\$2 or organic or resin)) and (plasma with (prim\$4 or clean\$3 or treat\$4 or pretreat\$4 or radical or etch\$3)) and (plasma near4 polymeri\$7) and ((PVD or \$3CVD or (vapor near2 deposit\$3) or sputter\$3) near5 (metal\$3 or Cu or copper or tin or Sn or silver or Ag or palladium or Pd or platinum or Pt or gold or Au))) not ((metal\$10 near5 (polymer\$2 or organic or resin)) and (plasma with (prim\$4 or clean\$3 or treat\$4 or pretreat\$4 or radical or etch\$3)) and (plasma near4 polymeri\$7) and ((PVD or \$3CVD or (vapor near2 deposit\$3) or sputter\$3) near5 (metal\$3 or Cu or copper or tin or Sn or silver or Ag or palladium or Pd or platinum or Pt or gold or Au)) and (electroless or (electro adj less) or electroplat\$3 or electrolytic\$5))	EPO; JPO; DERWENT; IBM_TDB	2003/10/23 11:24
-	10	(metal\$10 near5 (polymer\$2 or organic or resin)) and (plasma with (prim\$4 or clean\$3 or treat\$4 or pretreat\$4 or radical or etch\$3)) and (plasma near4 polymeri\$7) and ((PVD or \$3CVD or (deposit\$3) or sputter\$3) near5 (metal\$3 or Cu or copper or tin or Sn or silver or Ag or palladium or Pd or platinum or Pt or gold or Au))	EPO; JPO; DERWENT; IBM_TDB	2003/10/23 11:27
-	5	((metal\$10 near5 (polymer\$2 or organic or resin)) and (plasma with (prim\$4 or clean\$3 or treat\$4 or pretreat\$4 or radical or etch\$3)) and (plasma near4 polymeri\$7) and ((PVD or \$3CVD or (deposit\$3) or sputter\$3) near5 (metal\$3 or Cu or copper or tin or Sn or silver or Ag or palladium or Pd or platinum or Pt or gold or Au))) not ((metal\$10 near5 (polymer\$2 or organic or resin)) and (plasma with (prim\$4 or clean\$3 or treat\$4 or pretreat\$4 or radical or etch\$3)) and (plasma near4 polymeri\$7) and ((PVD or \$3CVD or (vapor near2 deposit\$3) or sputter\$3) near5 (metal\$3 or Cu or copper or tin or Sn or silver or Ag or palladium or Pd or platinum or Pt or gold or Au)))	EPO; JPO; DERWENT; IBM_TDB	2003/10/23 11:28

-	380	((427/437,443.1).CCLS.) or ((205/158,165).CCLS.) or ((205/205).CCLS.)) and ((427/488,491).CCLS.) or ((427/533,534,535,536).CCLS.) or ((427/304,305).CCLS.) or ((427/306).CCLS.))	USPAT; US-PGPUB	2003/10/23 11:30
-	24	((427/488,491).CCLS.) ((427/533,534,535,536).CCLS.) ((427/537).CCLS.) ((427/250,255.6,255.7).CCLS.) ((427/304,305).CCLS.) ((427/306).CCLS.) ((427/437,443.1).CCLS.) ((204/192.14).CCLS.) ((205/158,165).CCLS.) ((205/205).CCLS.)) and (metalliz\$6 near5 (polymer\$2 or organic or resin)) and (plasma with (clean\$3 or treat\$4 or pretreat\$4 or radical or etch\$3 or polymeriz\$7)) and ((PVD or \$3CVD or (vapor near2 deposit\$3) or sputter\$3) near5 (metal\$3 or Cu or copper or tin or Sn or silver or Ag or palladium or Pd or platinum or Pt or gold or Au))	USPAT; US-PGPUB	2003/10/23 11:35
-	116	(metalliz\$6 near5 (polymer\$2 or organic or resin)) and (plasma with (clean\$3 or treat\$4 or pretreat\$4 or radical or etch\$3 or polymeriz\$7)) and ((PVD or \$3CVD or (vapor near2 deposit\$3) or sputter\$3) near5 (metal\$3 or Cu or copper or tin or Sn or silver or Ag or palladium or Pd or platinum or Pt or gold or Au)) and (electroless or (electro adj less) or electroplat\$5 or (electrolytic\$5))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/10/23 11:36